

FEATURES

Advanced Power MOSFET

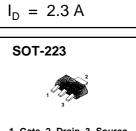
IRFM120A

 $BV_{DSS} = 100 V$

 $R_{DS(on)} = 0.2 \Omega$

IEEE802.3af Compatible

- □ Avalanche Rugged Technology
- □ Rugged Gate Oxide Technology
- Lower Input Capacitance
- □ Improved Gate Charge
- □ Extended Safe Operating Area
- \square Lower Leakage Current : 10 μA (Max.) @ V_{DS} = 100V
- \Box Lower R_{DS(ON)} : 0.155 Ω (Typ.)



1. Gate 2. Drain 3. Source

Symbol	Characteristic	Value	Units	
V _{DSS}	Drain-to-Source Voltage	100	V	
	Continuous Drain Current (T _A =25°C)	2.3		
Ι _D	Continuous Drain Current (T _A =70°C)	1.84	- A	
I _{DM}	Drain Current-Pulsed ①	18	А	
V _{GS}	Gate-to-Source Voltage	±20	V	
E _{AS}	Single Pulsed Avalanche Energy (2)	123	mJ	
I _{AR}	Avalanche Current (1)	2.3	А	
E _{AR}	Repetitive Avalanche Energy (1)	0.24	mJ	
dv/dt	Peak Diode Recovery dv/dt 3	6.5	V/ns	
P _D	Total Power Dissipation $(T_A=25^{\circ}C)^*$	2.4	W	
• 0	Linear Derating Factor *	0.019	W/℃	
- -	Operating Junction and			
T_J , T_STG	Storage Temperature Range	- 55 to +150	20	
	Maximum Lead Temp. for Soldering		C	
Τ _L	Purposes, 1/8" from case for 5-seconds	300		

Absolute Maximum Ratings

Thermal Resistance

Symbol	Characteristic	Тур.	Max.	Units
$R_{\Theta JA}$	Junction-to-Ambient *		52	°C/W

* When mounted on the minimum pad size recommended (PCB Mount).

Symbol	Characteristic	Min.	Тур.	Max.	Units	Test Condition	
BV_{DSS}	Drain-Source Breakdown Voltage	100			V	V _{GS} =0V,I _D =250µA	
$\Delta \text{BV} / \Delta \text{T}_{\text{J}}$	Breakdown Voltage Temp. Coeff.		0.12		V/℃	I _D =250μA See Fig 7	
V _{GS(th)}	Gate Threshold Voltage	2.0		4.0	V	V _{DS} =5V,I _D =250µA	
	Gate-Source Leakage, Forward			100	nA	V _{GS} =20V	
I _{GSS}	Gate-Source Leakage, Reverse			-100	ΠA	V _{GS} =-20V	
				1		V _{DS} =30V (6)	
I _{DSS}	Drain-to-Source Leakage Current			10	μA	V _{DS} =100V	
				100		V _{DS} =80V,T _A =125℃	
R _{DS(on)}	Static Drain-Source On-State Resistance			0.2	Ω	V _{GS} =10V,I _D =1.15A ④	
9 _{fs}	Forward Transconductance		3.12		S	V _{DS} =40V,I _D =1.15A ④	
C _{iss}	Input Capacitance		370	480			
C _{oss}	Output Capacitance		95	110	рF	$V_{GS}=0V, V_{DS}=25V, f=1MHz$	
C _{rss}	Reverse Transfer Capacitance		38	45	-		See Fig 5
t _{d(on)}	Turn-On Delay Time		14	40			
t _r	Rise Time		14	40	ns	V _{DD} =50V,I _D =9.2A,	
t _{d(off)}	Turn-Off Delay Time		36	90		R _G =18Ω	
t _f	Fall Time		28	70		See Fig 13 ④ 5	
Q _q	Total Gate Charge		16	22		V _{DS} =80V,V _{GS} =10V,	
Q _{gs}	Gate-Source Charge		2.7		nC	I _D =9.2A	
Q _{gd}	Gate-Drain("Miller") Charge		7.8			See Fig 6 & Fig 12 ④ 5	

Electrical Characteristics (T _A =25 °C	unless	otherwise	specified)
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Source-Drain Diode Ratings and Characteristics

Symbol	Characteristic	Min.	Тур.	Max.	Units	Test Condition
ا _s	Continuous Source Current			2.3	^	Integral reverse pn-diode
I _{SM}	Pulsed-Source Current ①			18	A	in the MOSFET
V _{SD}	Diode Forward Voltage ④			1.5	V	T _J =25 ℃,I _S =2.3A,V _{GS} =0V
t _{rr}	Reverse Recovery Time		98		ns	T _J =25℃,I _F =9.2A
Q _{rr}	Reverse Recovery Charge		0.34		μC	di _F /dt=100A/µs ④

Notes;

① Repetitive Rating : Pulse Width Limited by Maximum Junction Temperature

② L=35mH, I_{AS}=2.3A, V_{DD}=25V, R_G=27 Ω , Starting T_J=25[°]C

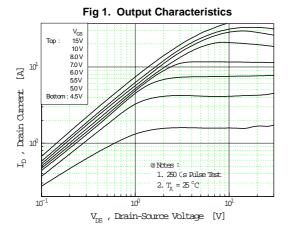
3 I_{SD}{\leq}9.2A, di/dt{\leq}300A/\mu s, V_{DD}{\leq}BV_{DSS} , Starting T_J=25 \degree C

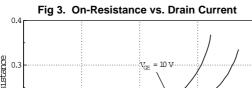
④ Pulse Test : Pulse Width = $250\mu s$, Duty Cycle $\leq 2\%$

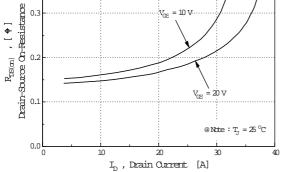
(5) Essentially Independent of Operating Temperature

(6) Adjusted for Cisco

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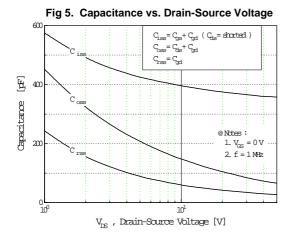


Fig 2. Transfer Characteristics

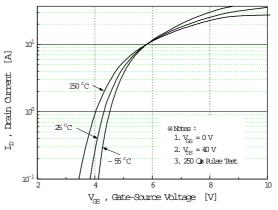
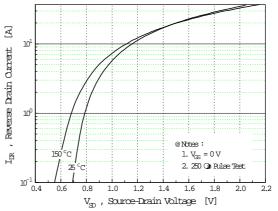
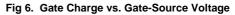
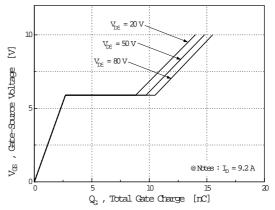


Fig 4. Source-Drain Diode Forward Voltage







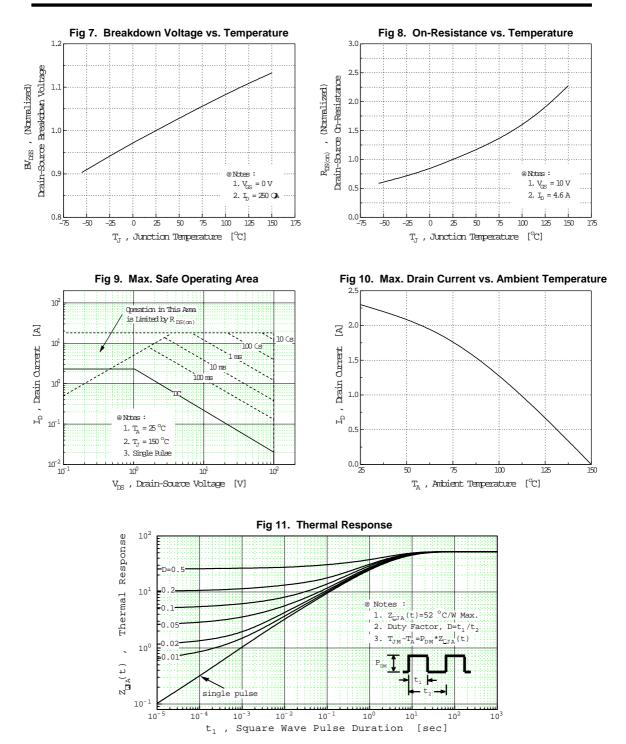
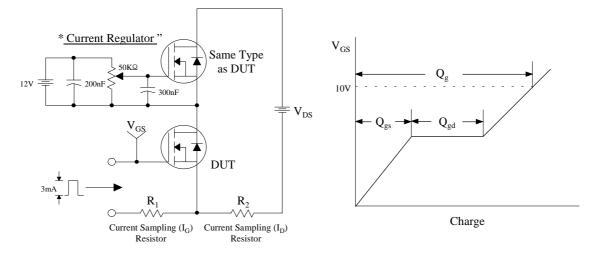
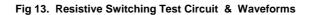


Fig 12. Gate Charge Test Circuit & Waveform





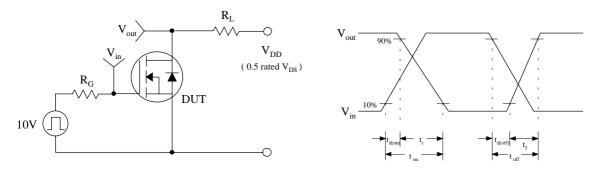
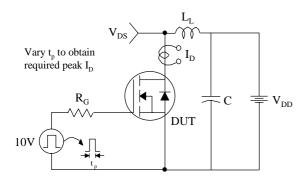
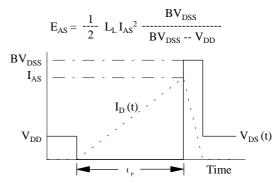


Fig 14. Unclamped Inductive Switching Test Circuit & Waveforms





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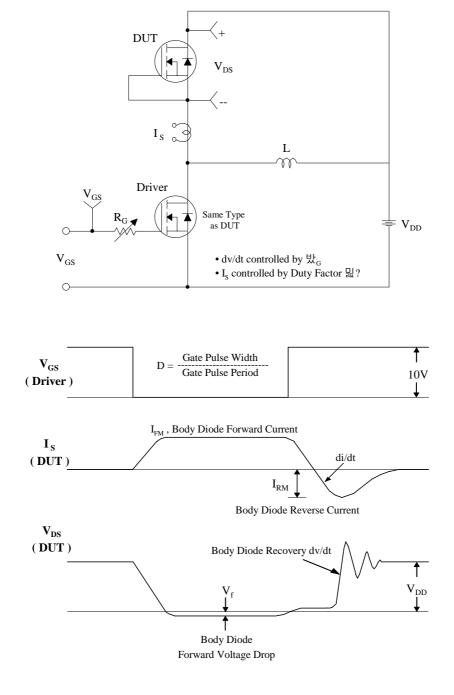


Fig 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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